

20V N-CHANNEL ENHANCEMENT MODE MOSFET

SUMMARY

 $V_{(BR)DSS}=20V$; $R_{DS(ON)}=0.18\Omega$; $I_{D}=1.7A$

DESCRIPTION

This new generation of high density MOSFETs from Zetex utilises a unique structure that combines the benefits of low on-resistance with fast switching speed. This makes them ideal for high efficiency, low voltage, power management applications.

SOT23

FEATURES

- Low on-resistance
- · Fast switching speed
- · Low threshold
- · Low gate drive
- SOT23 package

APPLICATIONS

- DC DC Converters
- · Power Management Functions
- · Disconnect switches
- Motor control



DEVICE	REEL SIZE (inches)	TAPE WIDTH (mm)	QUANTITY PER REEL
ZXM61N02FTA	7	8mm embossed	3000 units
ZXM61N02FTC	13	8mm embossed	10000 units

G

D



DEVICE MARKING

N02

ABSOLUTE MAXIMUM RATINGS.

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V _{DSS}	20	V
Gate Source Voltage	V _{GS}	± 12	V
Continuous Drain Current (V_{GS} =4.5V; T_A =25°C)(b) (V_{GS} =4.5V; T_A =70°C)(b)	I _D	1.7 1.3	А
Pulsed Drain Current (c)	I _{DM}	7.4	Α
Continuous Source Current (Body Diode) (b)	Is	0.8	Α
Pulsed Source Current (Body Diode)	I _{SM}	7.4	Α
Power Dissipation at T _A =25°C (a) Linear Derating Factor	P_{D}	625 5	mW mW/°C
Power Dissipation at T _A =25°C (b) Linear Derating Factor	P_{D}	806 6.4	mW mW/°C
Operating and Storage Temperature Range	T _j :T _{stg}	-55 to +150	°C

THERMAL RESISTANCE

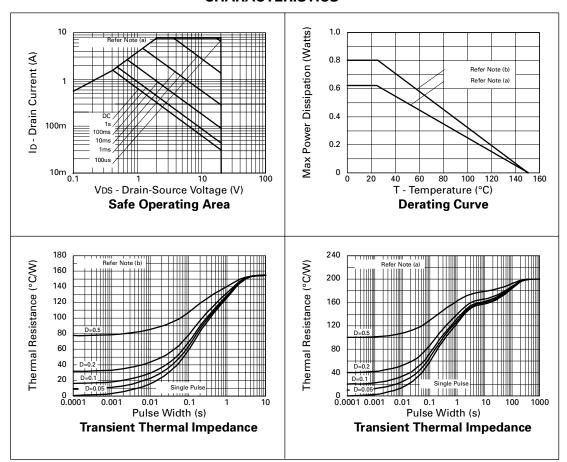
PARAMETER	SYMBOL	VALUE	UNIT
Junction to Ambient (a)	$R_{\theta JA}$	200	°C/W
Junction to Ambient (b)	$R_{\theta JA}$	155	°C/W

NOTES

- (a) For a device surface mounted on 25mm x 25mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions
- (b) For a device surface mounted on FR4 PCB measured at t≤5 secs.
- (c) Repetitive rating pulse width limited by maximum junction temperature. Refer to Transient Thermal Impedance graph.



CHARACTERISTICS





ELECTRICAL CHARACTERISTICS (at T_A = 25°C unless otherwise stated).

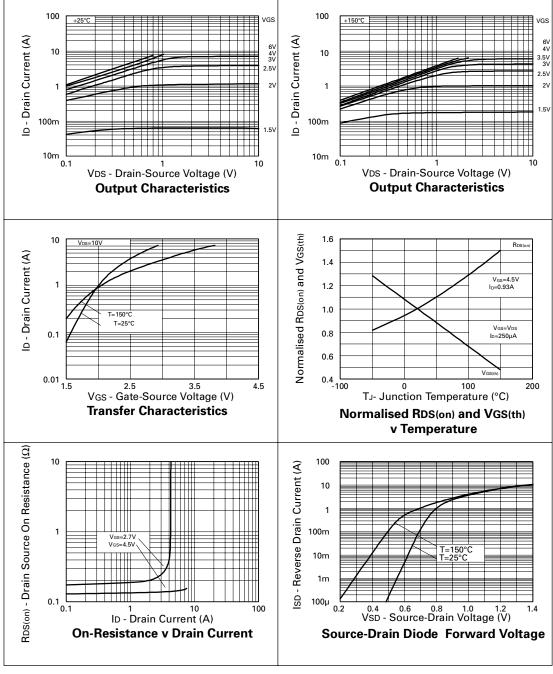
PARAMETER	SYMBOL	MIN.	TYP.(3)	MAX.	UNIT	CONDITIONS.	
STATIC							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	20			V	I _D =250μA, V _{GS} =0V	
Zero Gate Voltage Drain Current	I _{DSS}			1	μА	V _{DS} =20V, V _{GS} =0V	
Gate-Body Leakage	I _{GSS}			100	nA	V _{GS} =± 12V, V _{DS} =0V	
Gate-Source Threshold Voltage	V _{GS(th)}	0.7			V	$I_{D}=250 \mu A, V_{DS}=V_{GS}$	
Static Drain-Source On-State Resistance (1)	R _{DS(on)}			0.18 0.24	Ω	V_{GS} =4.5V, I_{D} =0.93A V_{GS} =2.7V, I_{D} =0.47A	
Forward Transconductance (3)	g _{fs}	1.3			s	V _{DS} =10V,I _D =0.47A	
DYNAMIC (3)	<u> </u>						
Input Capacitance	C _{iss}		160		pF	V _{DS} =15 V, V _{GS} =0V, f=1MHz	
Output Capacitance	Coss		50		pF		
Reverse Transfer Capacitance	C _{rss}		30		pF	-	
SWITCHING(2) (3)	•		•		•		
Turn-On Delay Time	t _{d(on)}		2.4		ns		
Rise Time	t _r		4.2		ns	V_{DD} =10V, I_{D} =0.93A R_{G} =6.2 Ω , R_{D} =11 Ω (refer to test circuit)	
Turn-Off Delay Time	t _{d(off)}		7.8		ns		
Fall Time	t _f		4.2		ns		
Total Gate Charge	Qg			3.4	nC	10/1/	
Gate-Source Charge	Q _{gs}			0.41	nC	$V_{DS}=16V, V_{GS}=4.5V, I_{D}=0.93A$	
Gate-Drain Charge	Q_{gd}			0.8	nC	(refer to test circuit)	
SOURCE-DRAIN DIODE				1		1	
Diode Forward Voltage (1)	V _{SD}			0.95	V	T _J =25°C, I _S =0.93A, V _{GS} =0V	
Reverse Recovery Time (3)	t _{rr}		12.9		ns	T _J =25°C, I _F =0.93A, di/dt= 100A/μs	
Reverse Recovery Charge (3)	Q _{rr}		5.2		nC		

NOTES

- (1) Measured under pulsed conditions. Width \leq 300 μ s. Duty cycle \leq 2% .
- (2) Switching characteristics are independent of operating junction temperature.
- (3) For design aid only, not subject to production testing.

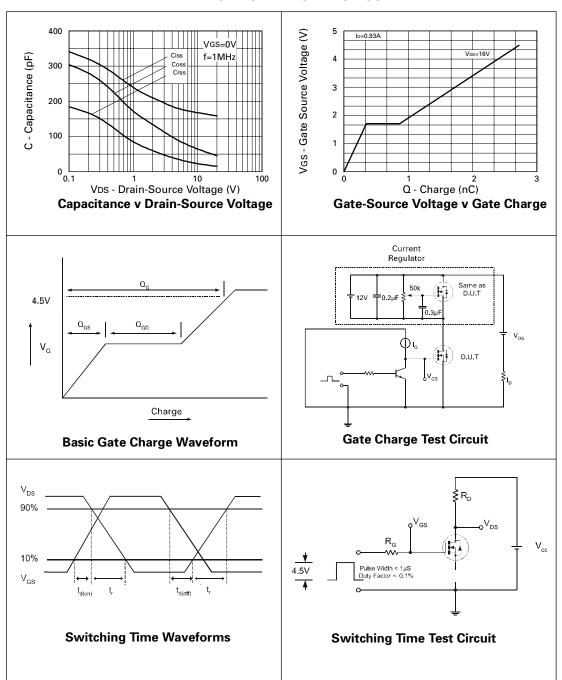


TYPICAL CHARACTERISTICS



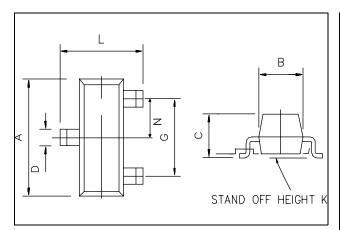


TYPICAL CHARACTERISTICS



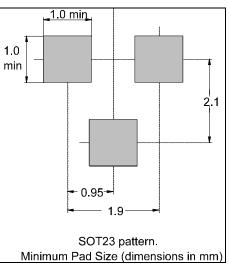


PACKAGE DIMENSIONS



DIM	Millimetres		Inches		
	Min	Max	Min	Max	
Α	2.67	3.05	0.105	0.120	
В	1.20	1.40	0.047	0.055	
С	_	1.10	_	0.043	
D	0.37	0.53	0.0145	0.021	
F	0.085	0.15	0.0033	0.0059	
G	NOM 1.9		NOM 0.075		
K	0.01	0.10	0.0004	0.004	
L	2.10	2.50	0.0825	0.0985	
N	NOM 0.95		NOM 0.037		

PAD LAYOUT DETAILS





Zetex plc.
Fields New Road, Chadderton, Oldham, OL9-8NP, United Kingdom.
Telephone: (44)161 622 4422 (Sales), (44)161 622 4444 (General Enquiries)
Fax: (44)161 622 4420

Zetex GmbH Streitfeldstraße 19 D-81673 München Germany

Telefon: (49) 89 45 49 49 0 Fax: (49) 89 45 49 49 49 Zetex Inc. 47 Mall Drive, Unit 4 Commack NY 11725 USA

Telephone: (516) 543-7100 Fax: (516) 864-7630 Zetex (Asia) Ltd. 3510 Metroplaza, Tower 2 Hing Fong Road, Kwai Fong, Hong Kong Telephone:(852) 26100 611 Fax: (852) 24250 494

These are supported by agents and distributors in major countries world-wide ©Zetex plc 1999

Internet:http://www.zetex.com

This publication is issued to provide outline information only which (unless agreed by the Company in writing) may not be used, applied or reproduced for any purpose or form part of any order or contract or be regarded as a representation relating to the products or services concerned. The Company reserves the right to alter without notice the specification, design, price or conditions of supply of any product or service.

